TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHCT373AF, TC74VHCT373AFT, TC74VHCT373AFK

Octal D-Type Latch with 3-State Output

The TC74VHCT373A is an advanced high speed CMOS OCTAL LATCH with 3-STATE OUTPUT fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

This 8-bit D-type latch is controlled by a latch enable input (LE) and an output enable input ( $\overline{OE}$ ).

When the  $\overline{OE}$  input is high, the eight outputs are in a high impedance state.

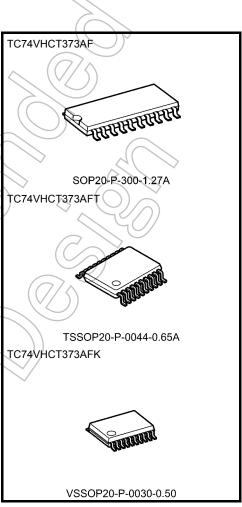
The input voltage are compatible with TTL output voltage. This device may be used as a level converter for interfacing  $3.3\ V$  to  $5\ V$  system.

Input protection and output circuit ensure that 0 to 5.5~V can be applied to the input and output  $^{(Note)}$  pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.

Note: Output in off-state

#### **Features**

- High speed:  $t_{pd} = 7.7 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- Compatible with TTL inputs:  $V_{IL} = 0.8 \text{ V (max)}$  $V_{IH} = 2.0 \text{ V (min)}$
- Power down protection is provided on all inputs and outputs.
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Low noise: VOLP = 1.5 V (max)
- Pin and function compatible with the 74 series (74AC/HC/F/ALS/LS etc.) 373 type.

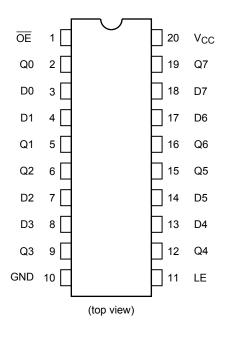


Weight

SOP20-P-300-1.27A: 0.22 g (typ.) TSSOP20-P-0044-0.65A: 0.08 g (typ.) VSSOP20-P-0030-0.50: 0.03 g (typ.)

## **Pin Assignment**

# **IEC Logic Symbol**



OE(1) LE(11)	EN C1	
D0 (3) D1 (4) D2 (7) D3 (8) D4 (13) D5 (14) D6 (17) D7 (18)	1D > V	(2) Q0 (5) Q1 (6) Q2 (9) Q3 (12) Q4 (15) Q5 (16) Q6 (19) Q7

## **Truth Table**

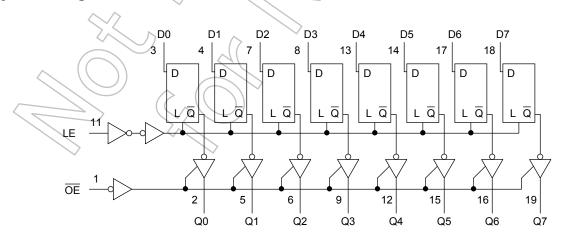
	Inputs	Output	
ŌĒ	LE	D	Output
Н	Х	Х	Z
L	L	Х	Qn
L	Н	L	L
L	Н	Н	Н

X: Don't care

Z: High impedance

Qn: Q outputs are latched at the time when the LE input is taken to a low logic level.

# **System Diagram**



#### **Absolute Maximum Ratings (Note 1)**

Characteristics Symbol		Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
DC output voltage	V	-0.5 to 7.0 (Note 2)	V
	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	lok	±20 (Note 4)	mA
DC output current	lout	±25	)) mA
DC V <sub>CC</sub> /ground current	Icc	±75	mA
Power dissipation	P <sub>D</sub>	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C (

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in off-state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

# **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage	$\bigvee_{CC}$	4.5 to 5.5	V
Input voltage	→ V <sub>IN</sub>	0 to 5.5	V
Output voltage	V-5	0 to 5.5 (Note 2	V
Output voltage	Vout	0 to V <sub>CC</sub> (Note 3	_
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall time	dt/dV	0 to 20	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 2:  $V_{CC} = 0 V$ 

Note 3: High or low state



#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			7	Га = 25°(		Ta −40 to	1 = 0 85°C	Unit
	,				Min	Тур.	Max	Min	Max	
High-level input voltage	V <sub>IH</sub>		_	4.5 to 5.5	2.0	_ <		2.0	_	V
Low-level input voltage	V <sub>IL</sub>		_	4.5 to 5.5	_	_	0.8	)>	0.8	V
High-level output	V/~··	V <sub>IN</sub>	I <sub>OH</sub> = -50 μA	4.5	4.40	4.50	) <del>/</del> /	4.40	_	V
voltage		= V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -8 mA	4.5	3.94	7	$\mathcal{A}$	3.80	_	v
Low-level output	V <sub>OL</sub>	V <sub>IN</sub>	I <sub>OL</sub> = 50 μA	4.5	-(	0.0	0.1	_	0.1	V
voltage	VOL	= V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 8 mA	4.5	_		0.36	_	0.44	v
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5		<i>\</i>	±0.25	( <del>)</del>	±2.50	μΑ
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	> <u></u>	-	±0.1		±1.0	μΑ
Outcome to comple	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5			4.0	(4)	40.0	μA
Quiescent supply current	Ісст	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND		5.5	_	-((	1.35	>   	1.50	mA
Output leakage current	I <sub>OPD</sub>	V <sub>OUT</sub> = 5.5 \	v (	0	_		0.5	_	5.0	μΑ

# Timing Requirements (input: $t_r = t_f = 3$ ns).

Characteristics	Symbol	Test Condition		Та=	Ta = −40 to 85°C	Unit	
5.1d. doi.o.10.10	Cy		V <sub>CC</sub> (V)	Typ.	Limit	Limit	<b>5</b>
Minimum pulse width (LE)	t <sub>w (H)</sub>		5:0 ± 0.5	_	6.5	8.5	ns
Minimum set-up time	ts	(//) -	5.0 ± 0.5		1.5	1.5	ns
Minimum hold time	t <sub>h</sub>	<u> </u>	5.0 ± 0.5		3.5	3.5	ns





#### AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Tes	st Condition	Condition		Ta = 25°C		Ta = -40 to 85°C		Unit					
	5,,,,,,		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max						
Propagation delay time	t <sub>pLH</sub>	_	5.0 ± 0.5	15	_	7.7	12.3	1.0	13.5	ns					
(LE-Q)	$t_{pHL}$		0.0 _ 0.0	50	_	8.5 <	13.3	1.0	14.5	110					
Propagation delay time	t <sub>pLH</sub>		5.0 ± 0.5	15		5.1	8.5	1.0	9.5	ns					
(D-Q)	$t_{pHL}$	_	_			_ <del>_</del>	_	3.0 1 0.3	50	-	5.9	9.5	1.0	10.5	113
3-state output enable tpZL	$t_{pZL}$	R <sub>L</sub> = 1 kΩ	$R_L = 1 \text{ k}\Omega$ 5.0 ± 0.5	15	$\overline{\wedge}$	6.3	10.9	1.0	12.5	ns					
time	$t_{pZH}$			50	-	7.1	11.9	1.0	13.5						
3-state output disable time	t <sub>pLZ</sub>	R <sub>L</sub> = 1 kΩ	5.0 ± 0.5	50		8.8	11.2	1.0	12.0	ns					
Output to output skew	t <sub>osLH</sub>	(Note 1)	5.0 ± 0.5	50	1	<u></u>	1.0	$\mathcal{A}$	1.0	ns					
	t <sub>osHL</sub>			-					>						
Input capacitance	C <sub>IN</sub>		_			4 🚫	10 (	))	10	pF					
Output capacitance	C <sub>OUT</sub>		_			9	(7)	4)	/	pF					
Power dissipation capacitance	$C_{PD}$		A(	(Note 2)	_	25	7	>_	_	pF					

Note 1: Parameter guaranteed by design.

 $t_{OSLH} = |t_{DLHm} - t_{DLHn}|, t_{OSHL} = |t_{DHLm} - t_{DHLn}|$ 

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 (per latch)$$

And the total CPD when n pcs. of latch operate can be gained by the following equation:

 $C_{PD}$  (total) = 14 + 11:n

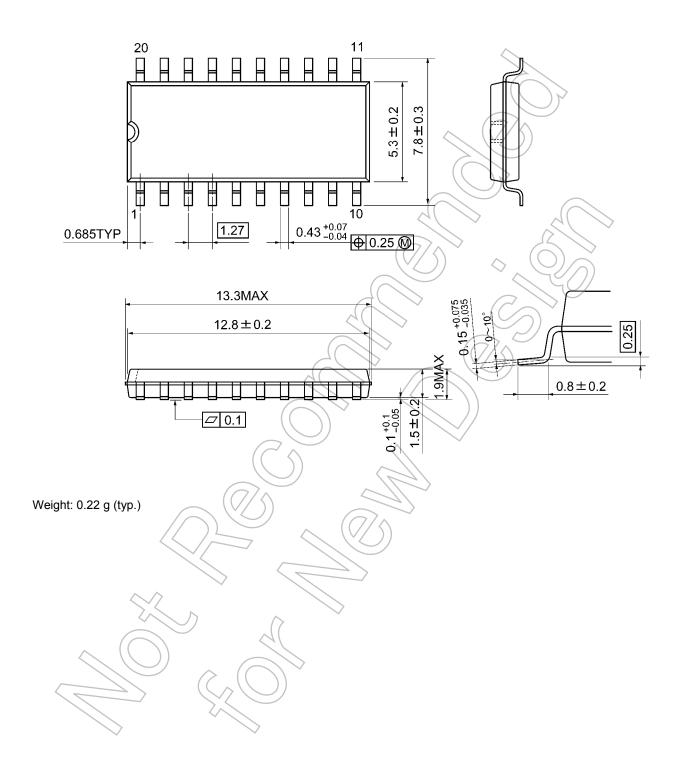
#### Noise Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta =	Unit	
Onaracteristics	Gymbol		V <sub>CC</sub> (V)	Тур.	Limit	Offic
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	1.1	1.5	٧
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-1.1	-1.5	٧
Minimum high level dynamic input voltage	VIHD	C <sub>L</sub> = 50 pF	5.0	_	2.0	V
Maximum low level dynamic input voltage	VILD	C <sub>L</sub> = 50 pF	5.0	_	0.8	V



# **Package Dimensions**

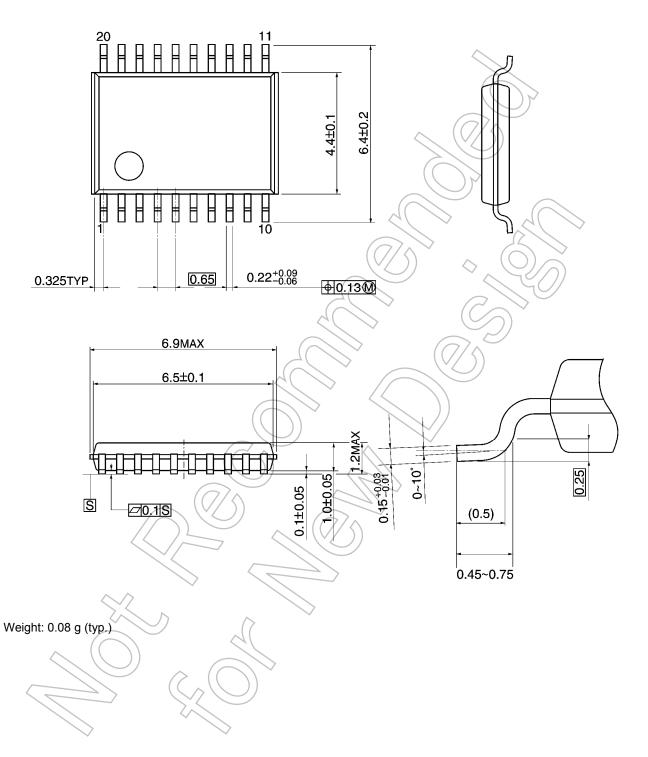
SOP20-P-300-1.27A Unit: mm



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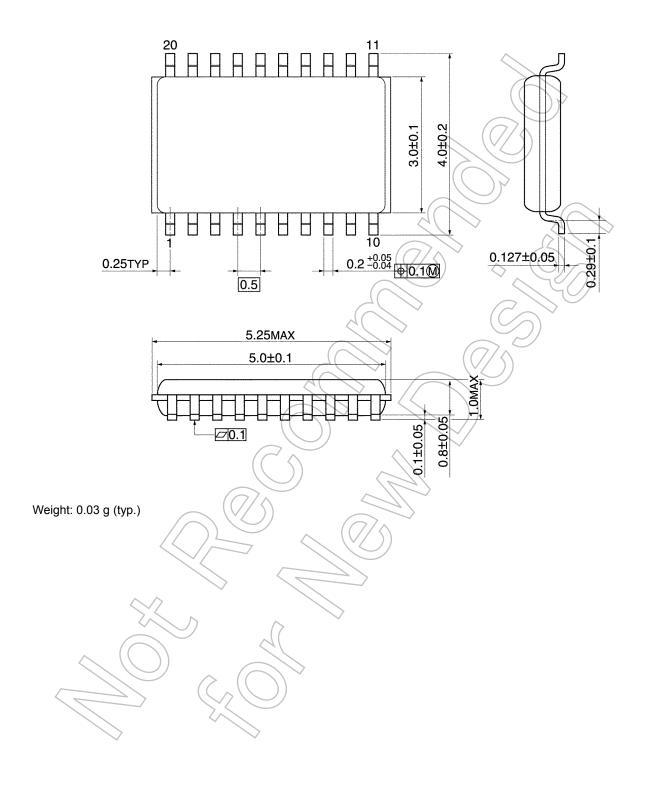
# **Package Dimensions**

TSSOP20-P-0044-0.65A Unit: mm



## **Package Dimensions**

VSSOP20-P-0030-0.50 Unit: mm



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